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OFFICE OF PETITIONSDocket No.: H0498.70130US01
(PATENT)**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Tao Deng
Serial No.: 10/763,819
Confirmation No.: 5026
Filed: January 23, 2004
For: FABRICATION OF METALLIC MICROSTRUCTURES VIA
EXPOSURE OF PHOTORESISTIVE COMPOSITION
Examiner: K. Duda
Art Unit: 1756

Certificate of Mailing Under 37 CFR 1.8(a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: 4/11/07

Signature

AFTER ALLOWANCE UNDER 37 C.F.R. §1.312

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Prior to issuance of the patent, applicant respectfully requests entry on this amendment under 37 C.F.R. 1.312 for the above-captioned patent application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.

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